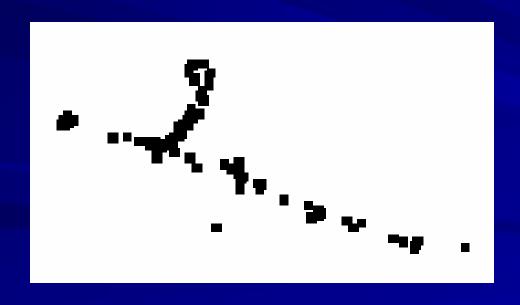
New developments on integrated MPGD, ageing and protection



MPGD Workshop CERN, January 20, 2006

Harry van der Graaf, NIKHEF, Amsterdam

GridPix:

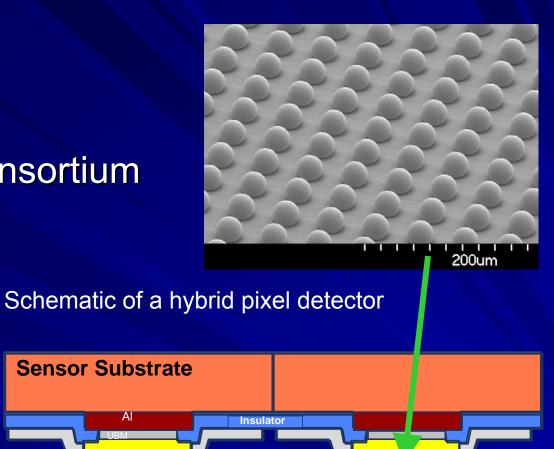
put active pixel sensor chip under MPGD:

integration of MPGD and FE electronics

GasGainGrid

CMOS pixel chip





MediPix chip
14 x 14 mm²
sensitive area

periphery

approved Eureka proposal

March 2003 Triple GEM + MediPix 2

January 2004 Single GEM + PIXIE chip

February 2004 Triple GEM + MediPix 2

March 2004 Micromegas + MediPix 2

Oct 2004 Double GEM + MediPix 2

June 2005 Triple GEM + MediPix 2

NIKHEF

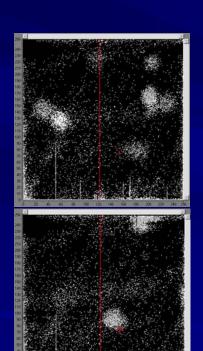
INFN-Pisa

NIKHEF

NIKHEF/Saclay/UnivTwente:

Freiburg

Freiburg



Drift Space

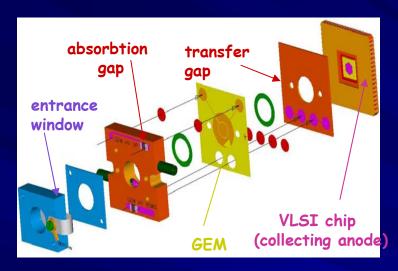
GEM foils

First events, recorded on March 29, 2003. Drift space irradiated with ⁵⁵Fe quanta Gas: Ar/Methane 90/10

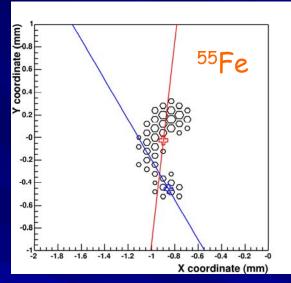
MediPix CMOS pixel sensor
Brass spacer block
Printed circuit board
Aluminium base plate

January 2004 Single GEM + PIXIE chip

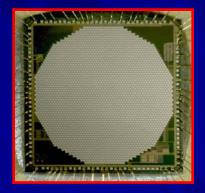
INFN-Pisa

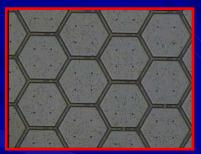


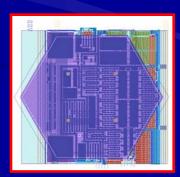




pixel electronics dimension: 80 µm x 80 µm in an hexagonal array, comprehensive of preamplifier/shaper, S/H and routing (serial read-out) for each pixel number of pixels: 2101

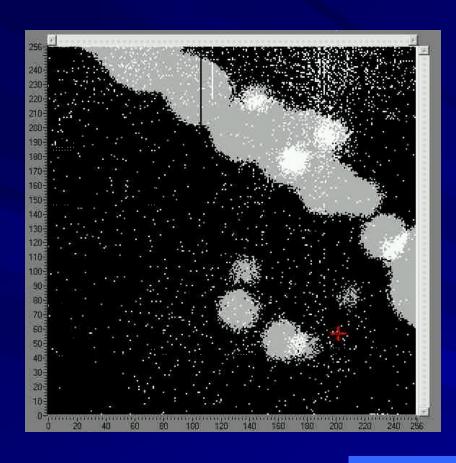






February 2004 Triple GEM + MediPix 2

NIKHEF



Drift Space

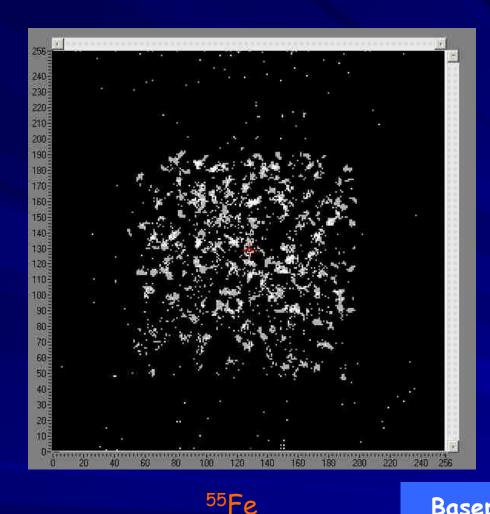
GEM foils

Gas: Ar/Isobutane 90/10

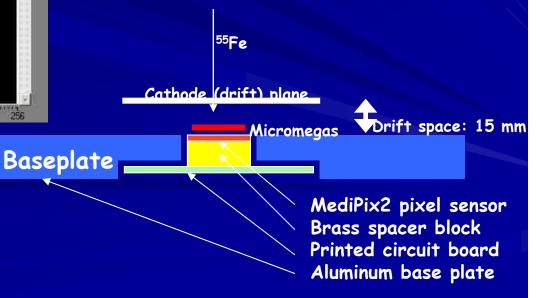
MediPix CMOS pixel sensor
Brass spacer block
Printed circuit board
Aluminium base plate

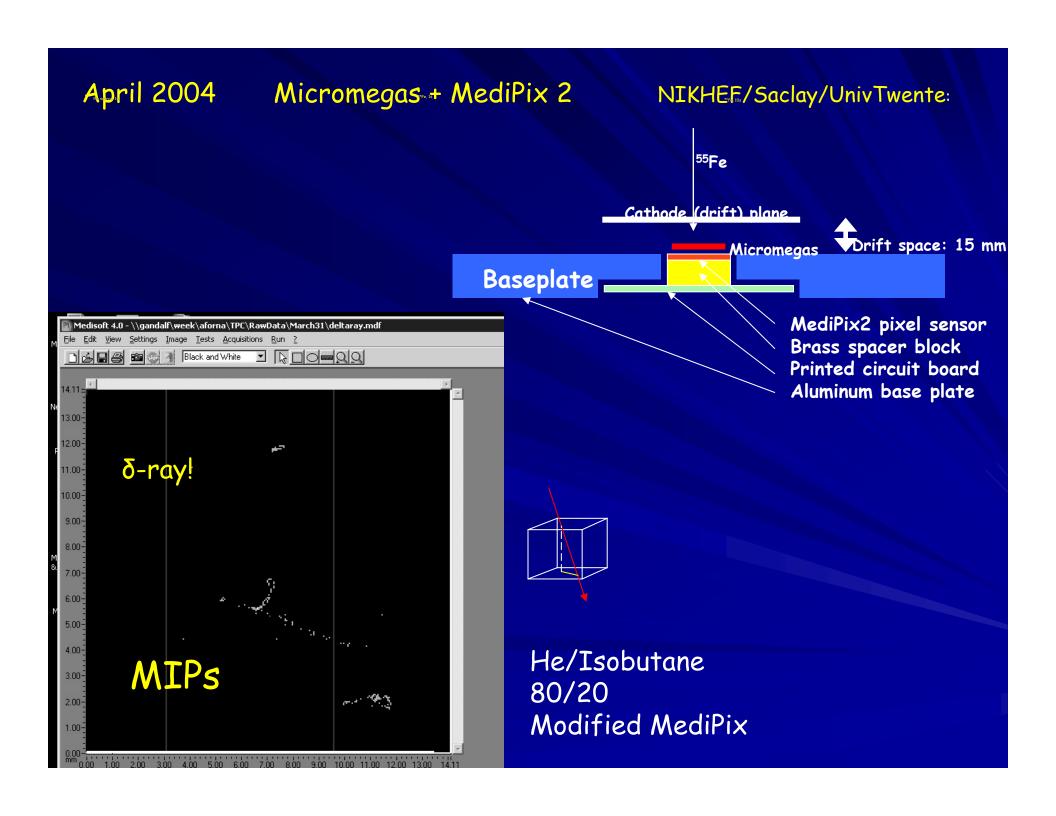
February 2004 Micromegas + MediPix 2

NIKHEE/Saclay/UnivTwente:



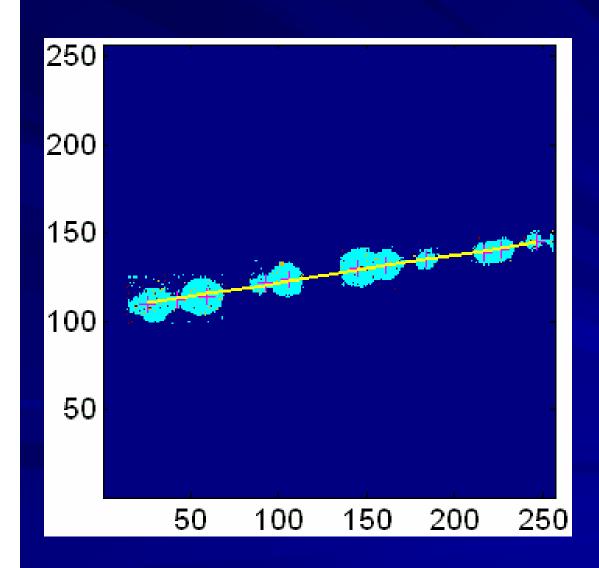
Very strong E-field above (CMOS) MediPix!

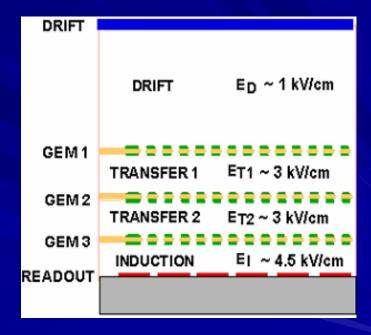




Jan 2004 Double GEM + MediPix 2 Freiburg GEM 5s Fe 3900V THL140.dat 1.8 50 1.6 1.4 100 1.2 150 0.8 0.6 200 0.4 E_D **DRIFT** 0.2 50 100 150 200 250 ET ΕĮ **INDUCTION 14 mm**

June 2005 Triple GEM + MediPix 2 Freiburg

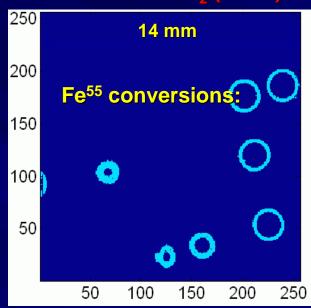


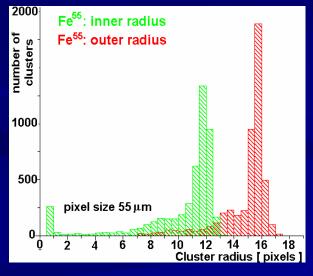


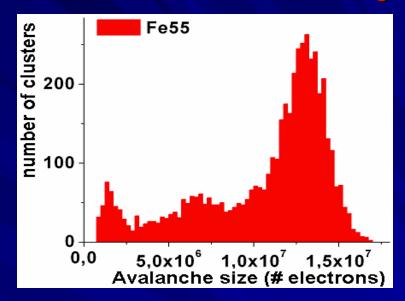
GEM and MEDIPIX2 Studies@ Freiburg

(A. Bamberger, K. Desch, J. Ludwig, U. Renz, M. Titov, N. Vlasov, A. Zwerger)









Fe⁵⁵ X-rays in Ar/CO₂:

Digital MEDIPIX2 chip, low and high thresholds (low discrim. thr ~ 1000 e⁻)

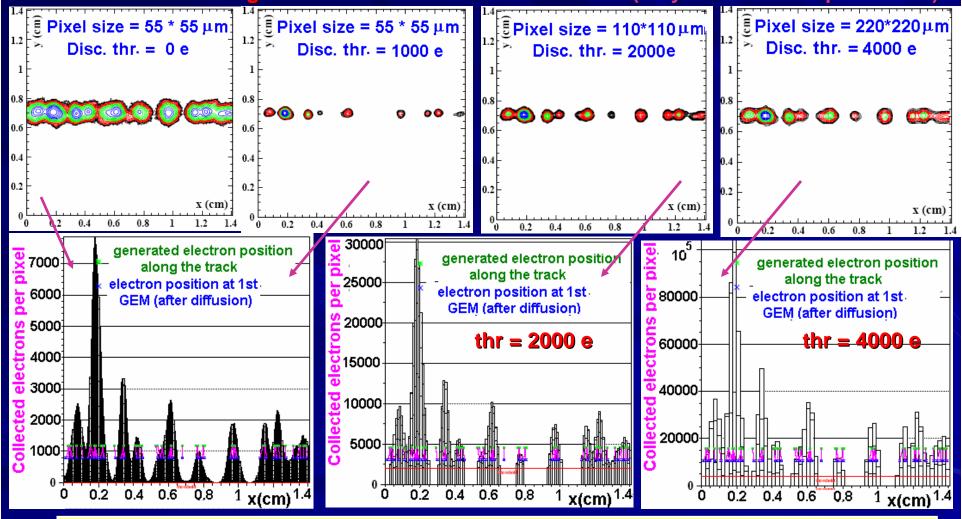
Chip calibration: DAC thr. vs injected charge

Estimate Fe⁵⁵ cluster charge from inner / outer cluster radius -> gain determination

GEM and MEDIPIX2 Simulation for Freiburg setup

Simulation studies were performed by Michael Hauschild (CERN)

• Contour Plot of charge distributions on MEDIPIX2 surface (vary thresholds & pixel sizes)



Pixel size of 55 * 55 μm is too small for TGEM and gain ~ 4*10⁴ → number of single electron clusters fall below the discriminator threshold (1000 e)
 Use of larger pixels (220 * 220 μm) improves S/N ratio → more clusters are detected

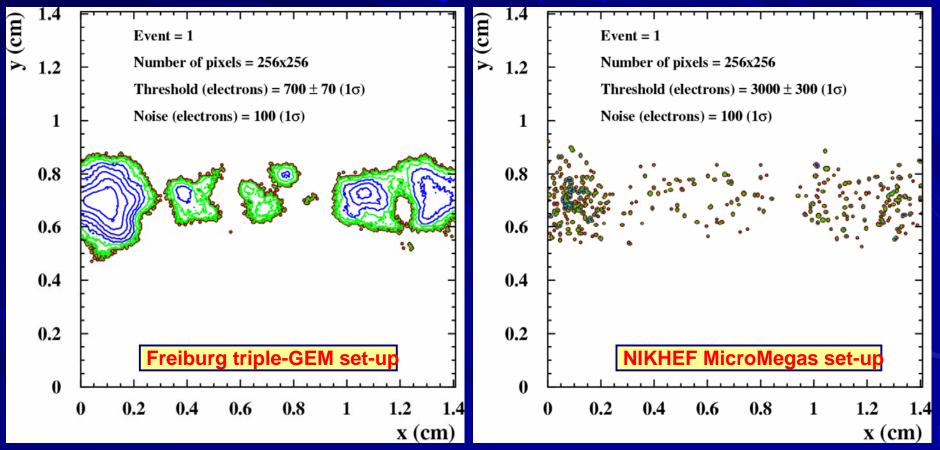
M. Hauschild's conclusions

- GEMs + MediPix
 - large "blobs" because of large diffusion among GEMs and to MediPix
 - electron cloud diluted over too many pixels, many pixels below threshold, single electrons clusters mainly undetected
 - solutions
 - reduce diffusion (optimize gas, E-field, GEM set-up)
 - use larger pixels, granularity still good enough for large "blobs"
- MicroMegas + MediPix
 - rather small "blobs" because of low diffusion between MicroMegas and MediPix
 - efficient to detect individual electrons, need to keep small pixel size
- GEMs vs MicroMegas
 - GEMs good to detect whole clusters, Micromegas single electrons
 - What do we need?
 - e.g. dE/dx needs cluster counting, not counting of electrons

Outlook

- ...at the ILC...
 - 100 GeV muon, B = 4 T, TESLA-TDR gas, 100 cm drift

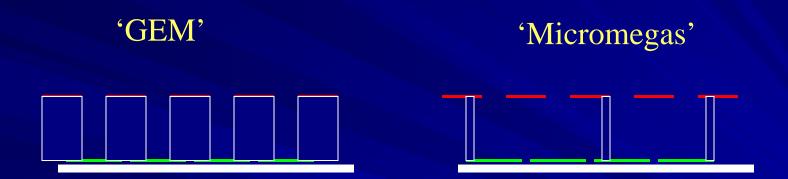
identical events: same generated primary clusters/electrons



- The matching of the granularity of an MPGD may require a short distance (< 1 mm) between the 1st GasGainGrid and the anode plane.
- With a single GasGainGrid placed at a distance of 50 µm from the anode plane, individual electrons can be detected within a (MediPix2)pixel (and future TimePix voxel). The maximum amount of information of the primary electrons can be extracted, only affected by diffusion.
- If the resolution of a track position measurement is limited by diffusion, then the information of all individual electrons will not result in a better resolution.
- If single electrons can be associated with primary clusters, then the dE/dX measurement can be based on cluster counting
- Optimising single electron-sensitive MPGD requires new algorithms for recognition of clusters, δ -rays, scattering, as well as a low-diffusion gas with large cluster distance

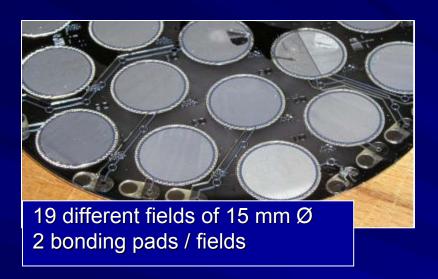
Integrate GEM/Micromegas and pixel sensor:

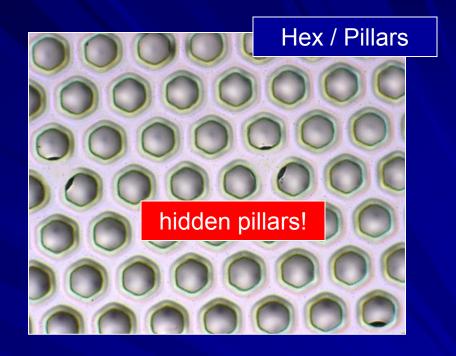
InGrid



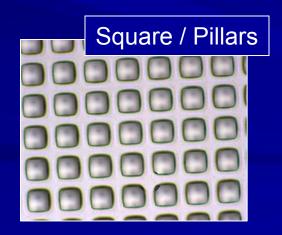
'wafer post processing'
by
Univ. of Twente, MESA+
approved VICI proposal
'there is plenty of room at the top'

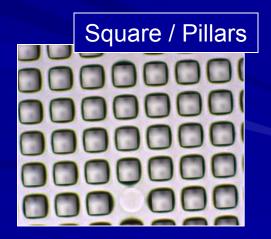
Prototypes



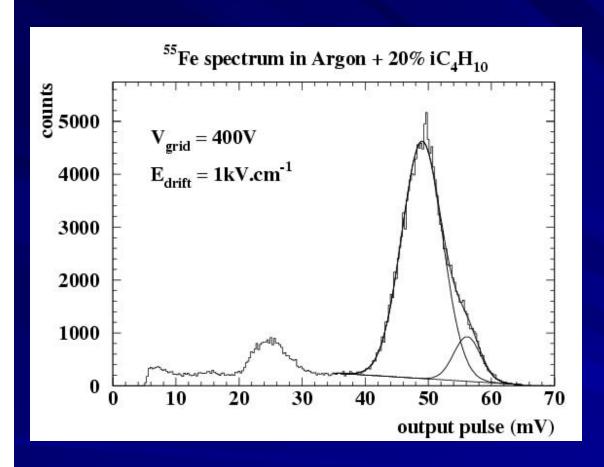


Square / Walls





Energy resolution in Argon IsoC₄H₁₀ 80/20



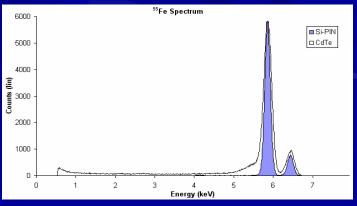
Very good energy resolution: Very precise dimensions d < 0.1 μm

Observation of two lines:

 K_{α} @ 5.9 keV

K_B @ 6.4 keV

- FWHM of the K_a distribution 16.7 %
- Gain fluctuations5%



The exponential distribution?

(in single electron response)

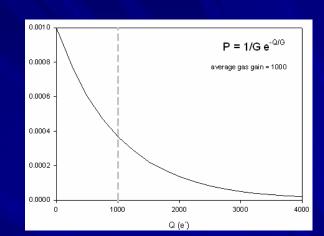
- Basic assumption
 - Ionization probability constant Townsend theory: $P_{ion}(dx) = a.dx$
- Analytic form

$$-P(n,x) = < n > -1$$
. $(1 - < n > -1)^{n-1}$

$$- < n > = e^{a.x}$$

$$- P(n,x) \sim < n > -1$$
. e $n < n > 0$ large n

$$-\sigma = \langle n \rangle$$



■ For 220 e- from ⁵⁵Fe in Argon

– Exp model: FWHM = 15.8 %

– InGrid: FWHM = 14.9 %

multiplication only all contributions

Avalanche fluctuations overestimated

1D Avalanche Model @ constant E

Input

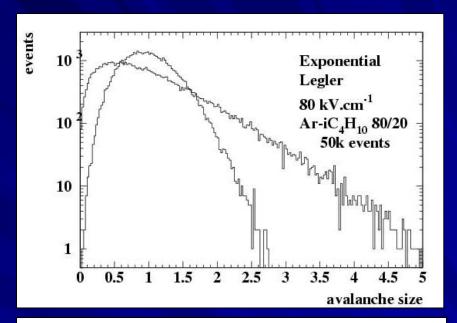
- E = 80 kV/cm
- Gap = 50 um
- $-\alpha$ from MAGBOLTZ (1950 cm⁻¹)
- a₀ from Legler
- "0" energy after ion.

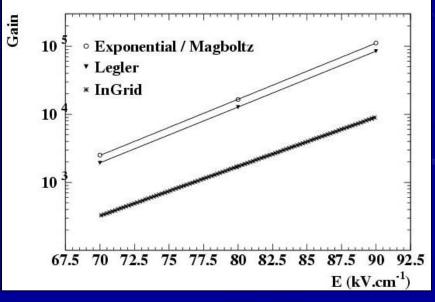
FWHM

- 6.4 % Legler
- 15.8 % Exp.
- 13.4 % InGrid (max)

■ Gain @ 80 kV/cm

- InGrid = 1750
- Exp = 17500!
- Legler = 12800 !





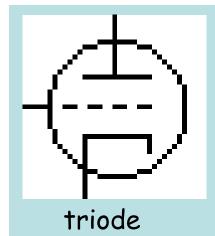
Smaller avalanche gap: we expect

- better energy resolution
- single electron response:
- smaller RMS
- better efficiency
- lower gain required

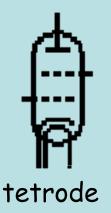
Downscaling hole pitch
hole diameter
avalanche gap
thus granularity, seems feasible

InGrid in preparation for MediPix

TimePix (approved EUDET: 300 kE!)
PSI 46 wafers



InGrid





pentode

'there is plenty of room at the top':

- single GasGainGrid looks like Micromegas
- dual grid: (much) lower field above fragile pixel chip: looks like GEM
- reduction of ion feedback may require 3rd grid...

There may be MPGDs in the future, without GEMs or Micromegas!

CMOS Chip protection against

- discharges
- sparks
- HV breakdowns
- too large signals

Amorph Si (segmented)

Emperical method: Try RPC technology

_ _ _ _

- RPC principle: reduction of local E-field (Werner Riegler)
- Avalanche charge: electrostatic induction towards input pad
- Specific resistance: high enough to 'block' avalanche charge
 - low enough to compensate signal current
 - layer thickness 4 μ m, $R_{vol} = 0.2 G\Omega/cm$
- Segmentation of A Si may be required to prevent preamp-preamp coupling

Technology

- A-Si deposits possible in general, but wafers may get too hot
- Univ. of Neuchatel/IMT/P. Jarron (CERN) uses this for integrated X-ray sensor/convertor on MediPix 2
- pre-poster post processing before application of InGrid

Applications of GridPix:

- Large TPC:

- μ-TPC:

- Transition Radiation Detectors:

- GOSSIP: hi rad vertex detector:

 $L_{drift} = 2000 \text{ mm}$

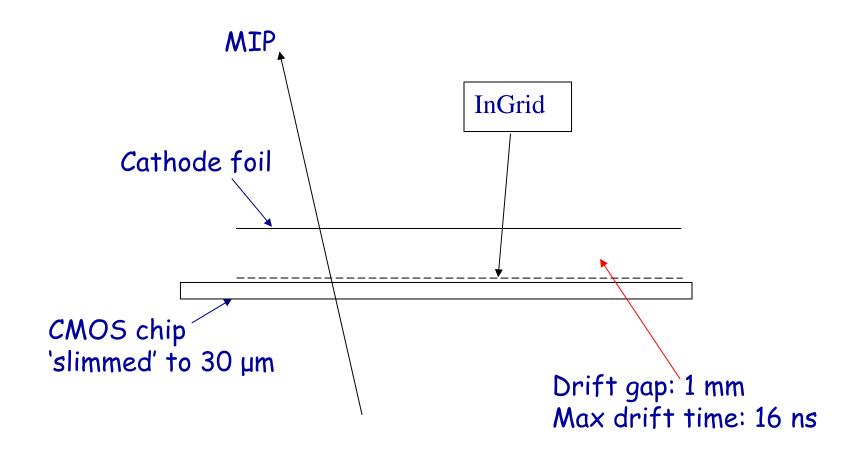
 $L_{drift} = 200 \text{ mm}$

 $L_{drift} = 20 \text{ mm}$

 $L_{drift} = 1 \text{ mm}$

Same principle:

- readout plane, including GasGainGrid + FE electronics
 - ultralight
 - low power (gas cooling!)
 - low cost (5 Euro/cm²)
 - # readout channels: not a cost issue
- drift space: application specific



GOSSIP: Gas On Slimmed SIlicon Pixels new vertex detector!

Essentials of GOSSIP:

- · Generate charge signal in gas instead of Si (e-/ions versus e-/holes)
- Amplify # electrons in gas (electron avalanche versus FET preamps)

Then:

- No radiation damage in depletion layer or pixel preamp FETs
- Little power dissipation of preamps
- No detector bias current
- Ultra light detection layer (Si foil)
- · less sensitive for background radiation (X-rays, n, gammas)

Vertex detectors:

- gas filled until 1980
- Domain of Si: strips, CCDs, pixels, MAPs
- back to gas-filled MPGDs!

Gossipo: MultiProjectWafer submit (0.13 µm technology) for ASD

Aging

Less aging of a GridPix detector versus wire chambers:

- Ratio of anode surface: thin wire surface versus anode plane (~20x)
- Low gas gain (1 k) due to fast signal and low source capacity (~20x)
 total factor: 400x
- E-field near (flat) anode factor ~3 less than E-field near wire surface

So: no issue for ILC-TPC

So: application as GOSSIP vertex detector in Super LHC seems feasible

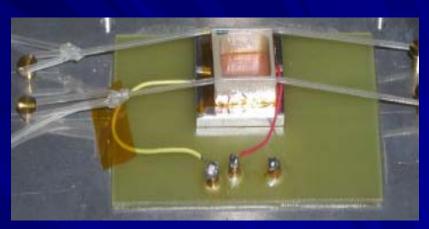
First try

Aging test (remember MSGCs...!)

Half the GridPix was irradiated with 8 keV X-rays.

Gas: normal Ar/Methane90/10 Many plastics included.





Chamber: Same as GridPix, but with polished Al plate as anode instead of MediPix



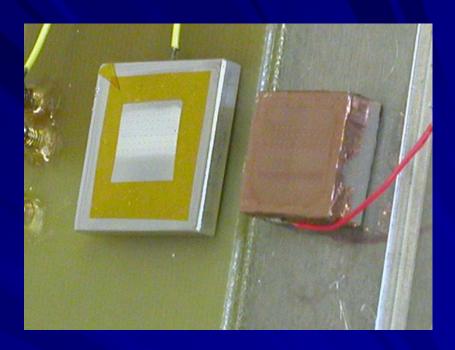
No rate effects up to anode current density of 0.2 μA / mm²

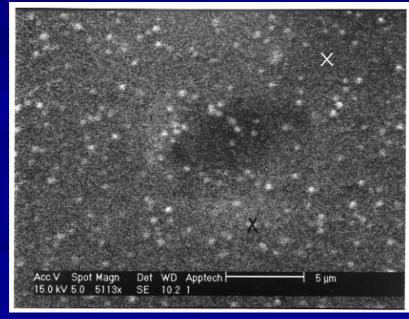
After <u>0.3 Coulomb/mm2</u>, deposit of carbon polymer on anode is clearly visible.

Micromegas is clean (!?)

Little deposit on cathode

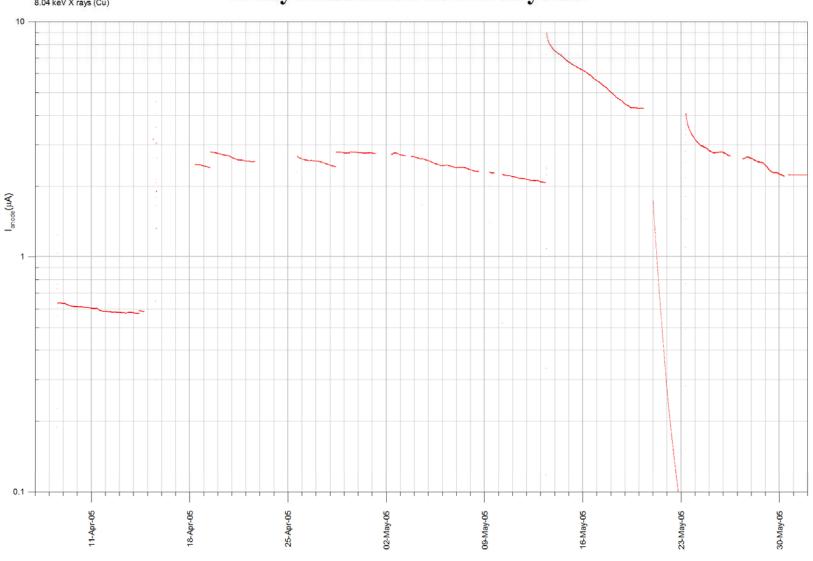
Very stable operation during exposure; current decrease significant after 24 h.



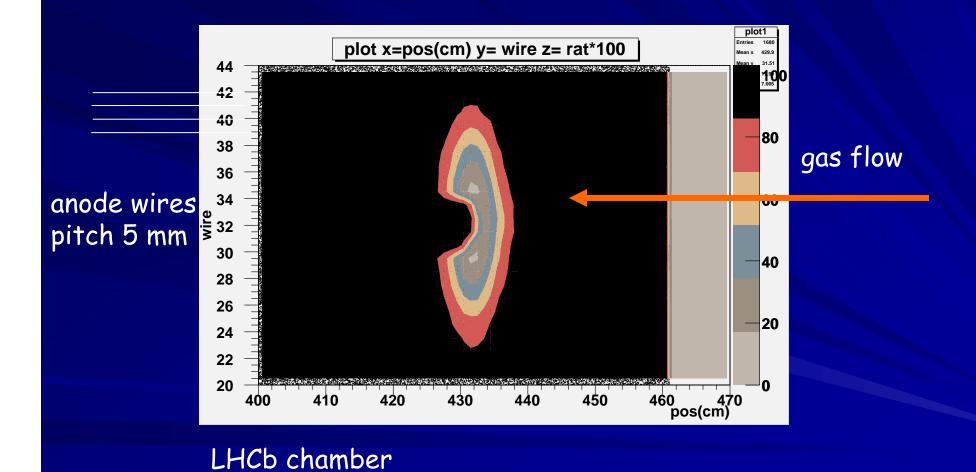


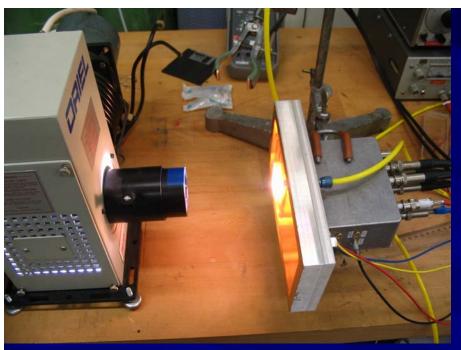


X ray irradiation at PANalytical



F. Sauli in NIM A 515 (2003) 358-363: '....a way to clean the gas...'





New attempt to solve/fight/learn about ageing

Ageing-free system: modify until there is No Ageing!

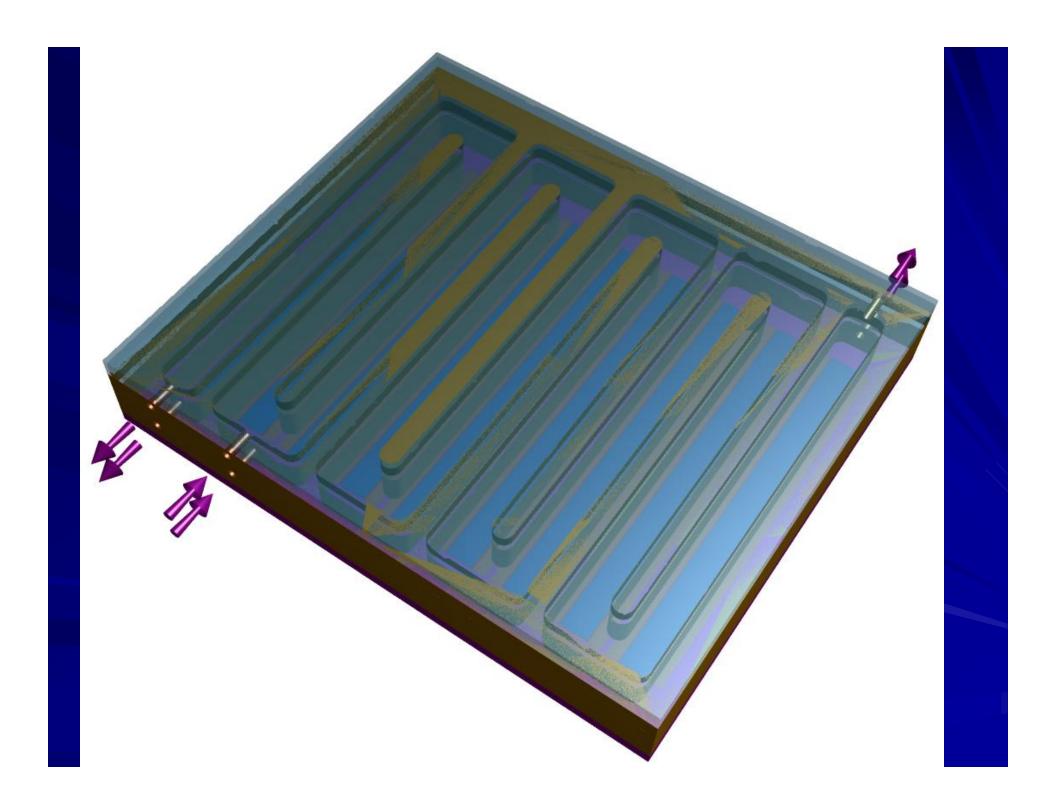
- construct GridPix chamber from non-ageing materials
- apply closed loop gas system (Ar/CO2/DME)
- irradiate cathode (mesh) with UV light (Xe lamp) \rightarrow 1 $\mu A/mm2$ anode current

Add (traces of) suspected compounds to chamber gas

- SiO₂, SiH₄, CSiH₆
- outgassing Teflon, Viton, G10, epoxy, ethanol, H2O etc

If ageing compound(s) are found:

- measure absorption efficiency
- apply active filters



As interaction material for detectors for charges particles, gas has certain advantages. New high-granularity, readout-integrated concepts may be preferred above Si detectors in the near future.

The stability of the gas gain process is better if there are as little as possible insulating materials facing the (avalanche) region with strong electrical field

The mail building block of a GridPix detector is a CMOS chip. Chip design manpower is required (highest level: ana-digi mix) in this period of detector R & D. The FE and DAQ electronics can not be separated from the detector, as has been the case so far. Example: Gossipo: PreampShaperDiscriminator MPW submit on $0.13~\mu m$ tech.

The present MPGD Detector R & D is NOT driven by LHC results. Always required: better resolution, better dE/dX, lighter, less power, radiation hard, no ageing, cheaper

